



NPN Power Silicon Transistor

Qualified per MIL-PRF-19500/315

Qualified Levels:
JAN, JANTX, and
JANTXV

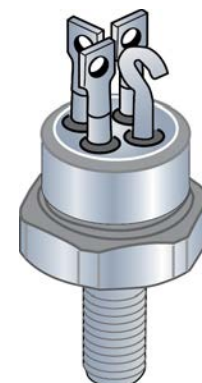
DESCRIPTION

This NPN silicon transistor is rated at 5 amps and is military qualified up to the JANTXV level. This TO-111 isolated package features a 180 degree lead orientation.

Important: For the latest information, visit our website <http://www.microsemi.com>.

FEATURES

- JEDEC registered 2N3749
- Low saturation voltage
- Low leakage current
- Fast switching capable - 0.5 μ s rise time
- High frequency response
- TO-111 case with isolated terminals
- JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/315
- RoHS compliant versions available (commercial grade only)



TO-111 Package

APPLICATIONS / BENEFITS

- Class 3B to ESD per MIL-STD-750 Method 1020
- High frequency inverters
- Converters
- Linear amplifiers
- High speed switching regulated power supplies
- RF power supplies

MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T _J and T _{STG}	-65 to +200	°C
Thermal Resistance Junction-to-Case	R _{ΘJC}	3.33	°C/W
Collector Current	I _C	5.0	A
Collector-Emitter Voltage	V _{CEO}	80	V
Collector-Base Voltage	V _{CBO}	110	V
Emitter-Base Voltage	V _{EBO}	8.0	V
Total Power Dissipation @ T _A = +25°C ⁽¹⁾ @ T _C = +100°C ⁽²⁾	P _T	2.0	W
		30	

Notes:

1. Derate linearly 11.4 mW/ $^{\circ}\text{C}$ for $T_A > +25^{\circ}\text{C}$.
2. Derate linearly 300 mW/ $^{\circ}\text{C}$ for $T_C > +100^{\circ}\text{C}$.

MSC – Lawrence

6 Lake Street,
Lawrence, MA 01841
1-800-446-1158
(978) 620-2600
Fax: (978) 689-0803

MSC – Ireland

Gort Road Business Park,
Ennis, Co. Clare, Ireland
Tel: +353 (0) 65 6840044
Fax: +353 (0) 65 6822298

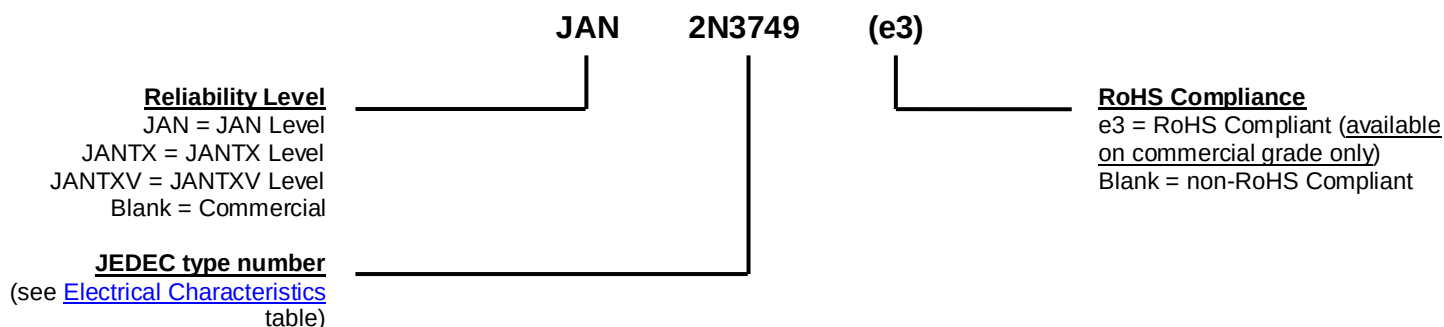
Website:

www.microsemi.com

MECHANICAL and PACKAGING

- CASE: Nickel Plated
- TERMINALS: Solder Dip over Nickel Plating. RoHS compliant Matte/Tin available on commercial grade only.
- MARKING: Manufacturer's ID, Date Code, Part Number, BeO
- POLARITY: See Package Outline Drawing on last page
- WEIGHT: Approximately 5.412 grams
- See [Package Dimensions](#) on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS

Symbol	Definition
I_B	Base current: The value of the dc current into the base terminal.
I_C	Collector current: The value of the dc current into the collector terminal.
I_E	Emitter current: The value of the dc current into the emitter terminal.
P_T	Total power dissipation: The sum of the forward and reverse power dissipations.
V_{BE}	Base-emitter voltage: The dc voltage between the base and the emitter.
V_{CE}	Collector-emitter voltage: The dc voltage between the collector and the emitter.
V_{CEO}	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.
V_{CB}	Collector-base voltage: The dc voltage between the collector and the base.
V_{CBO}	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.
V_{EB}	Emitter-base voltage: The dc voltage between the emitter and the base
V_{EBO}	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.

ELECTRICAL CHARACTERISTICS @ $T_C = 25^\circ\text{C}$ unless otherwise noted

Characteristic	Symbol	Min.	Max.	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage $I_C = 100\text{ mA}$	$V_{(BR)CEO}$	80		V
Collector-Emitter Breakdown Voltage $I_C = 10\text{ }\mu\text{A}$	$V_{(BR)CBO}$	110		V
Emitter-Base Breakdown to Voltage $I_E = 10\text{ }\mu\text{A}$	$V_{(BR)EBO}$	8.0		V
Collector-Emitter Cutoff Current $V_{CE} = 60\text{ V}$	I_{CEO}		20	μA
Collector-Base Cutoff Current $V_{CB} = 80\text{ V}$	I_{CBO}		0.2	μA
Collector-Emitter Cutoff Current $V_{CE} = 110\text{ V}, V_{BE} = -0.5$	I_{CEX}		1.0	μA
Emitter-Base Cutoff Current $V_{EB} = 6.0\text{ V}$	I_{EBO}		0.2	μA

ON CHARACTERISTICS

Forward-Current Transfer Ratio $I_C = 50\text{ mA}, V_{CE} = 5.0\text{ V}$ $I_C = 1.0\text{ A}, V_{CE} = 2.0\text{ V}$ $I_C = 5.0\text{ A}, V_{CE} = 5.0\text{ V}$	h_{FE}	40 40 15	120 120	
Base-Emitter Voltage Non-saturated $V_{CE} = 2.0\text{ V}, I_C = 1.0\text{ A}$	V_{BE}		1.2	V
Collector-Emitter Saturation Voltage $I_C = 1.0\text{ A}, I_B = 0.1\text{ A}$ $I_C = 5.0\text{ A}, I_B = 0.5\text{ A}$	$V_{CE(sat)}$		0.25 1.5	V
Base-Emitter Saturation Voltage $I_C = 1.0\text{ A}, I_B = 0.1\text{ A}$	$V_{BE(sat)}$		1.2	V

DYNAMIC CHARACTERISTICS

Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 1.0\text{ A}, V_{CE} = 10.0\text{ V}, f = 10\text{ MHz}$	$ h_{fe} $	3.0	12	
Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 50\text{ mA}, V_{CE} = 5.0\text{ V}, f = 1\text{ kHz}$	h_{fe}	40	140	
Output Capacitance $V_{CB} = 10\text{ V}, I_E = 0, 100 \leq f \leq 1.0\text{ MHz}$	C_{obo}		150	pF

SWITCHING CHARACTERISTICS

Pulse delay time	t_d		60	ns
Pulse rise time	t_r		300	ns
Pulse storage time	t_s		1.7	μs
Pulse fall time	t_f		300	ns

ELECTRICAL CHARACTERISTICS @ $T_C = 25^\circ\text{C}$ unless otherwise noted. (continued)
SAFE OPERATING AREA (See Figure below and [MIL-STD-750, Test Method 3053](#))
DC Tests
 $T_C = +100^\circ\text{C}$, $t = 10$ seconds

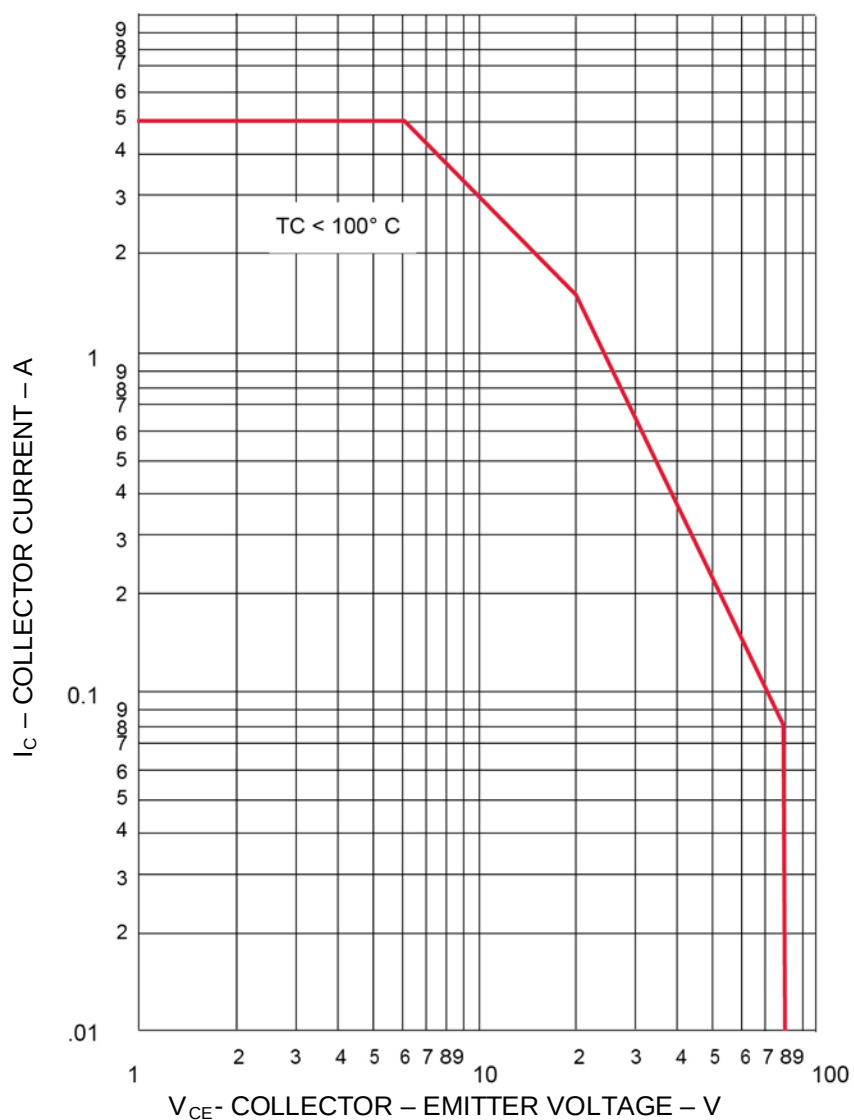
Test 1
 $V_{CE} = 80\text{ V}$, $I_C = 80\text{ mA}$
Test 2
 $V_{CE} = 20\text{ V}$, $I_C = 1.5\text{ A}$


FIGURE 1
Maximum Safe Operating Area

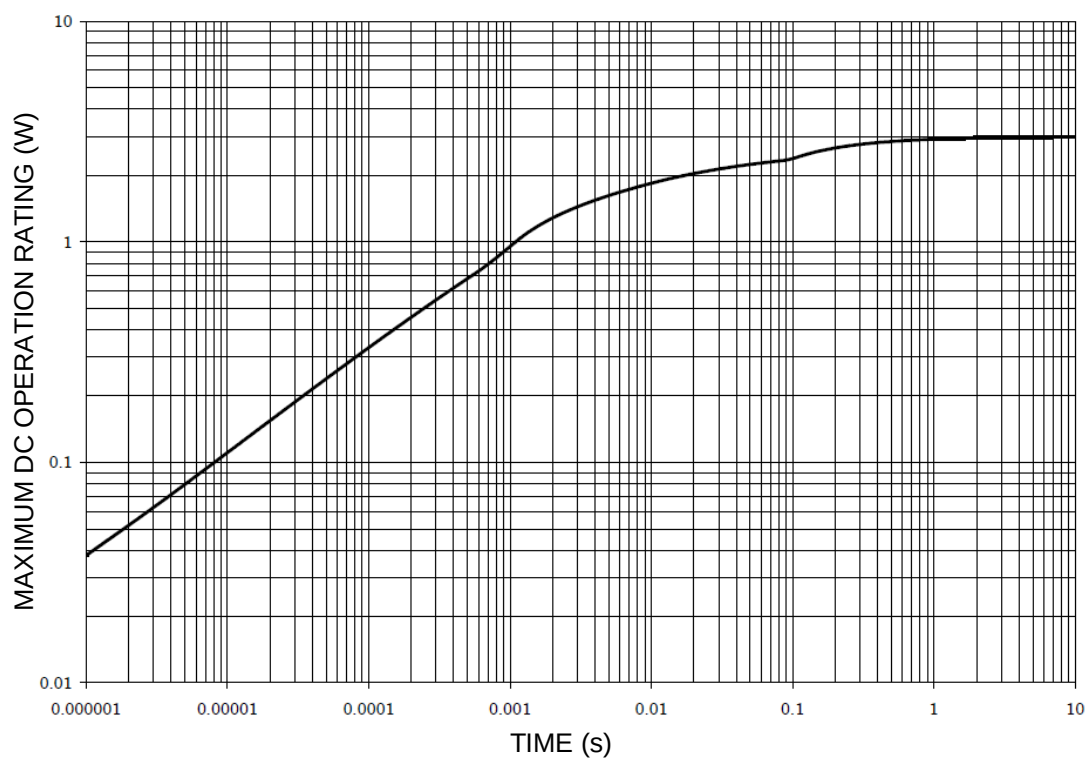
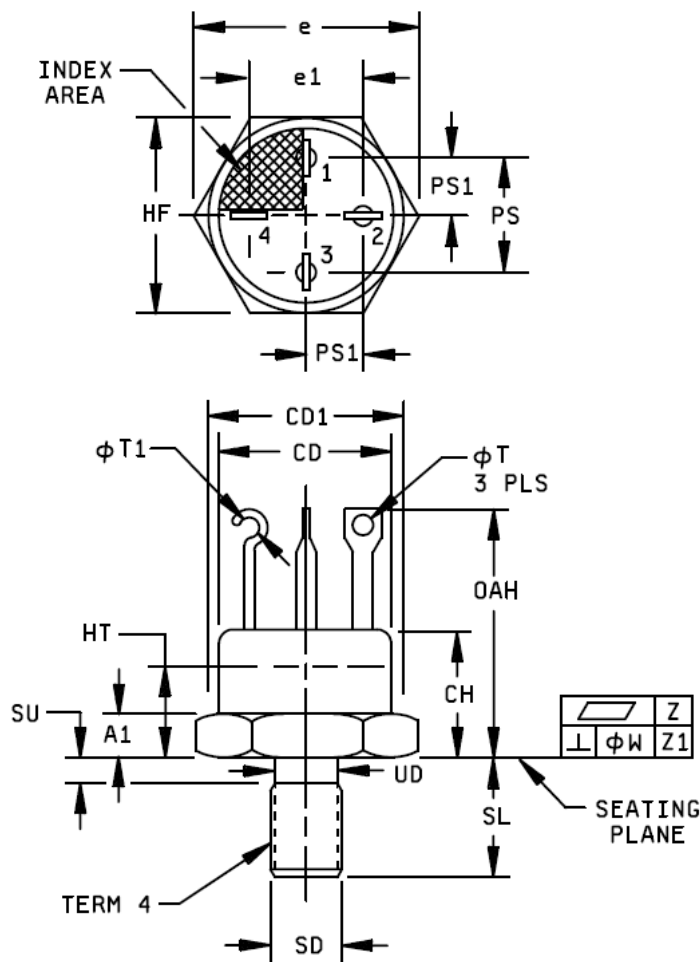
GRAPHS


FIGURE 2
Thermal Impedance

PACKAGE DIMENSIONS

NOTES:

1. Dimensions are in inches.
2. Millimeters are given for information only.
3. Terminal 1 - emitter; terminal 2 - base; terminal 3 - collector; terminal 4 - case.
4. Chamfer or undercut on one, or both, ends of hexagonal portion is optional.
5. The outline contour, with the exception of the hexagon, is optional within cylinder defined by $CD1$ and HT .
6. Terminal 4 can be flattened and pierced or hook type. A visual index is required when the flattened and pierced tab terminal contour (identical to the adjacent terminals) option is used.
7. Angular orientation of terminals with respect to hexagon is optional.
8. $A1$ dimension does not include sealing flanges.
9. SU is the length of incomplete or undercut threads.
10. SD is the outer diameter of coated threads. (Reference: Screw thread standards for Federal Standard H28/1, (FED-STD-H28/1))

Symbol	Dimension				Notes
	Inch		Millimeters		
	Min	Max	Min	Max	
CH	0.0320	0.458	8.13	11.63	
HT	-	0.250	-	6.35	5
CD	0.318	0.380	8.08	9.65	
CD1	0.380	0.437	9.65	11.10	5
HF	0.423	0.438	10.74	11.13	
E	-	0.505	-	12.83	
E1	0.180	0.215	4.57	5.46	7
A1	0.090	0.0150	2.29	3.81	4, 8
OA	0.570	0.763	14.48	19.38	
SL	0.400	0.0455	10.16	11.56	
SU	-	0.078	-	1.98	9
ϕT	0.040	0.065	1.02	1.65	
ϕT1	0.040	0.070	1.02	1.78	6
SD	0.190-32UNF-2A				10
Z	-	0.02	-	0.05	
Z1	-	0.006	-	0.15	